

MOSFET

OptiMOS[™] 5 Power-Transistor, 100 V

Features

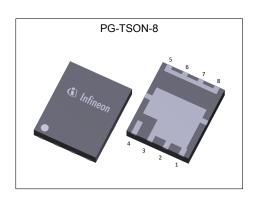
- N-channel, normal level
- Very low on-resistance R_{DS(on)}
 Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

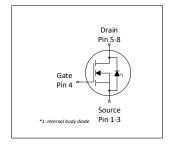
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

| rabio i regi orionnanco i aramotoro | | | | | | | |
|-------------------------------------|-------|------|--|--|--|--|--|
| Parameter | Value | Unit | | | | | |
| $V_{	extsf{DS}}$ | 100 | V | | | | | |
| R _{DS(on),max} | 2.05 | mΩ | | | | | |
| I _D | 276 | A | | | | | |
| Qoss | 125 | nC | | | | | |
| Q _G | 107 | nC | | | | | |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|-----------|---------|---------------|
| IQD020N10NM5 | PG-TSON-8 | 02010N5 | - |

OptiMOS[™] 5 Power-Transistor, 100 V



Table of Contents

| escription | 1 |
|------------------------------------|---|
| 1aximum ratings | 3 |
| hermal characteristics | 3 |
| lectrical characteristics | 4 |
| lectrical characteristics diagrams | 6 |
| ackage Outlines | 0 |
| evision History | 1 |
| rademarks 1 | 1 |
| nisclaimer | 1 |

OptiMOS[™] 5 Power-Transistor, 100 V IQD020N10NM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

| Danamatan | Ols al | Values | | | Ī., ., | | |
|--|-----------------------------------|-------------|-------------|-------------------------|--------|---|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Continuous drain current ¹⁾ | I _D | - - - | - - - | 276 195 169 26 | A | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =6 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W ²⁾ | |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 1104 | Α | <i>T</i> _C =25 °C | |
| Avalanche energy, single pulse ⁴⁾ | E AS | - | - | 756 | mJ | $I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω | |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - | |
| Power dissipation | P _{tot} | - | - | 333 3.0 | W | T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾ | |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 175 | °C | - | |

2 Thermal characteristics

Table 3 Thermal characteristics

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|--|-------------------|--------|------|------|-------|-----------------------|
| Farameter | Symbol | Min. | Тур. | Max. | Oilit | Note / Test Condition |
| Thermal resistance, junction - case | R _{thJC} | - | - | 0.45 | °C/W | - |
| Thermal resistance, junction - ambient, 6 cm² cooling area ²⁾ | R _{thJA} | - | - | 50 | °C/W | - |

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions. $^{2)}$ Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for source

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

| Danamatan | 0 | Values | | | | |
|----------------------------------|----------------------|--------|------------|--------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 100 | - | - | V | V _{GS} =0 V, I _D =1 mA |
| Gate threshold voltage | V _{GS(th)} | 2.2 | 3.0 | 3.8 | V | $V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 159 \ \mu {\rm A}$ |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1 100 | μΑ | V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C |
| Gate-source leakage current | I_{GSS} | - | 10 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V |
| Drain-source on-state resistance | R _{DS(on)} | - | 1.8 2.2 | 2.05 2.75 | mΩ | V _{GS} =10 V, I _D =50 A V _{GS} =6 V, I _D =25 A |
| Gate resistance | R _G | - | 0.58 | - | Ω | - |
| Transconductance | g fs | - | 160 | - | S | $ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 A$ |

Table 5 **Dynamic characteristics**

| Parameter | Crossball | Values | | | 11:4 | Note / Took Condition | |
|--|------------------|--------|------|------|------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Input capacitance ¹⁾ | Ciss | - | 7300 | 9500 | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz | |
| Output capacitance ¹⁾ | Coss | - | 1000 | 1300 | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz | |
| Reverse transfer capacitance ¹⁾ | C _{rss} | - | 42 | 74 | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz | |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 15 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω | |
| Rise time | t _r | - | 6 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω | |
| Turn-off delay time | $t_{\sf d(off)}$ | - | 28 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω | |
| Fall time | t _f | - | 7 | - | ns | $V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω | |

Table 6 Gate charge characteristics²⁾

| Develope | Oh al | | Values | | | |
|------------------------------------|----------------------|------|--------|------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge | Q _{gs} | - | 32 | - | nC | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge at threshold | $Q_{g(th)}$ | - | 22 | - | nC | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate to drain charge ¹⁾ | Q _{gd} | - | 23 | 35 | nC | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Switching charge | Q _{sw} | - | 33 | - | nC | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total ¹⁾ | Qg | - | 107 | 134 | nC | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate plateau voltage | V _{plateau} | - | 4.4 | - | V | $V_{\rm DD}$ =50 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total, sync. FET | Q _{g(sync)} | - | 93 | - | nC | V _{DS} =0.1 V, V _{GS} =0 to 10 V |
| Output charge ¹⁾ | Qoss | - | 125 | 166 | nC | V _{DS} =50 V, V _{GS} =0 V |

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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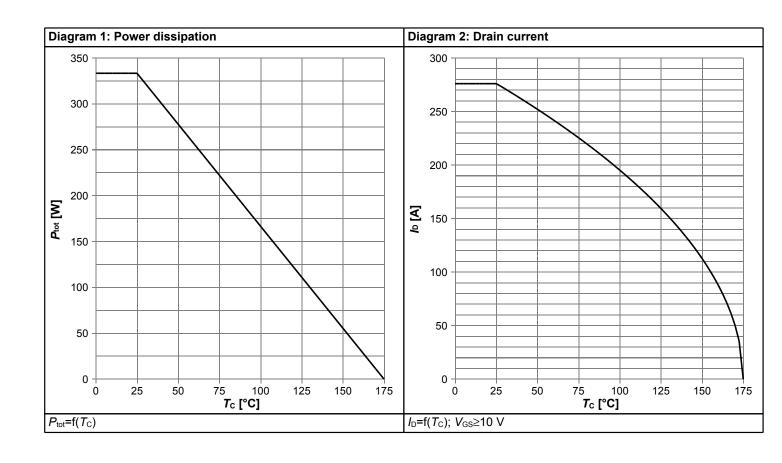


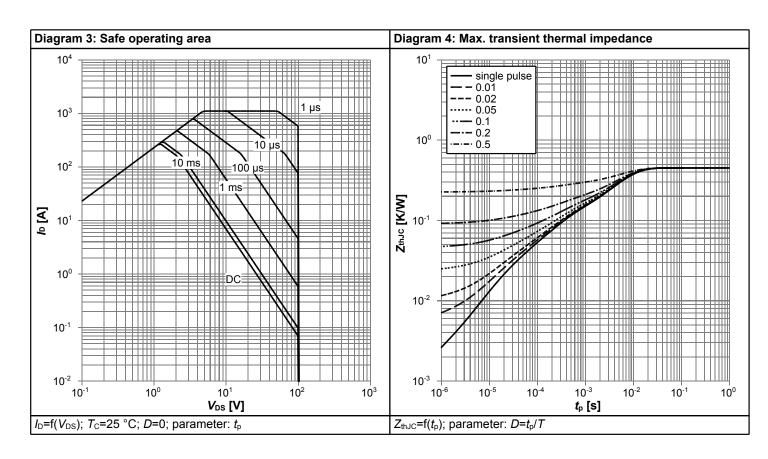
Table 7 Reverse diode

| Darameter | Cumbal | Values | | | 11 | Nata (Tant Oan differen |
|---------------------------------------|----------------------|--------|------|------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Diode continuous forward current | I _S | - | - | 256 | Α | <i>T</i> _C =25 °C |
| Diode pulse current | I _{S,pulse} | - | - | 1104 | Α | <i>T</i> _C =25 °C |
| Diode forward voltage | V _{SD} | - | 0.82 | 1.0 | V | V _{GS} =0 V, I _F =50 A, T _j =25 °C |
| Reverse recovery time ¹⁾ | t _{rr} | - | 48 | 96 | ns | V _R =50 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =100 A/μs |
| Reverse recovery charge ¹⁾ | Qrr | - | 71 | 142 | nC | V _R =50 V, I _F =25 A, d <i>i</i> _F /d <i>t</i> =100 A/μs |
| Reverse recovery time ¹⁾ | t _{rr} | - | 32 | 64 | ns | V _R =50 V, I _F =50 A, d <i>i</i> _F /d <i>t</i> =1000 A/μs |
| Reverse recovery charge ¹⁾ | Qrr | - | 447 | 894 | nC | V _R =50 V, I _F =50 A, d <i>i</i> _F /d <i>t</i> =1000 A/μs |

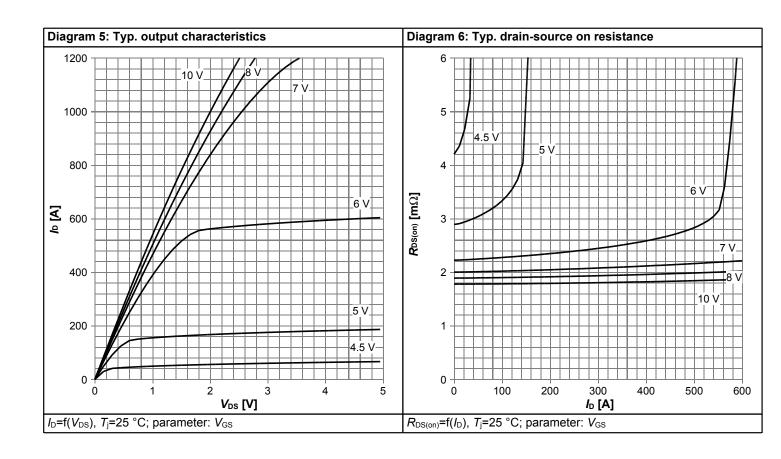


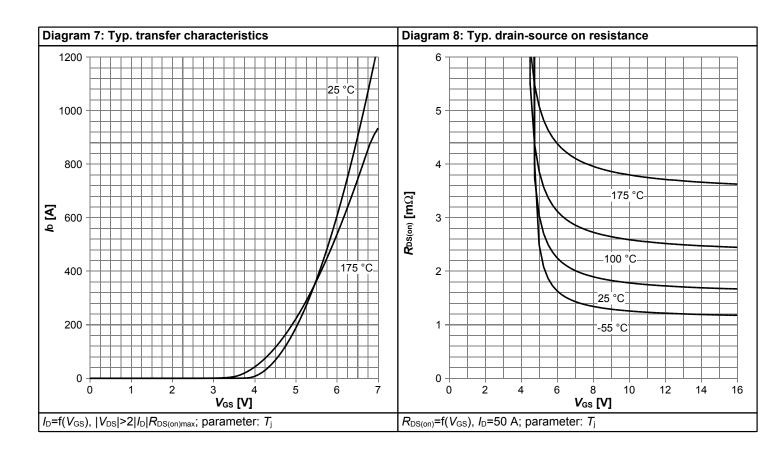
4 Electrical characteristics diagrams



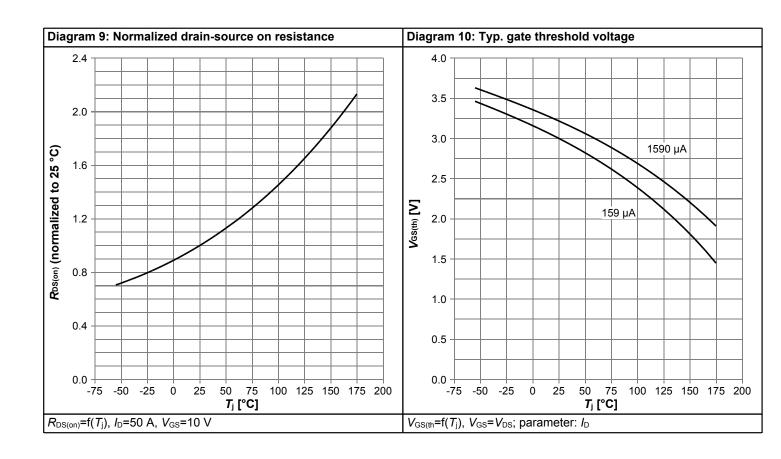


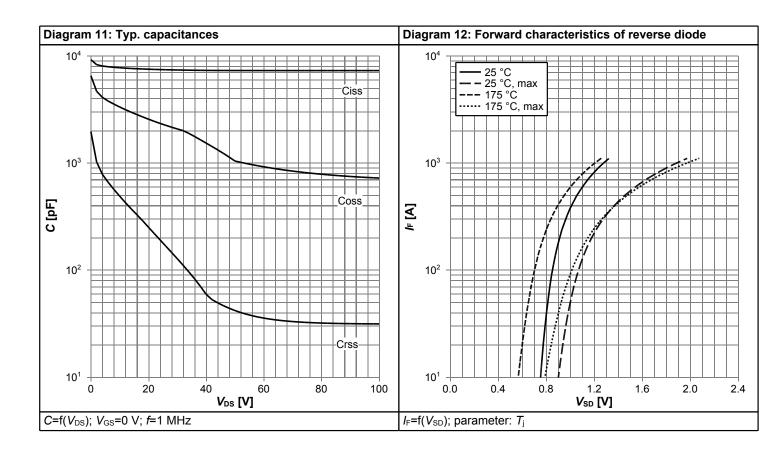




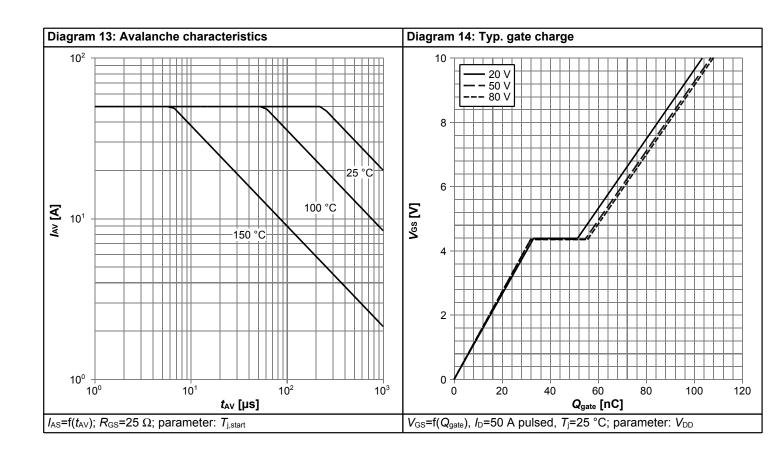


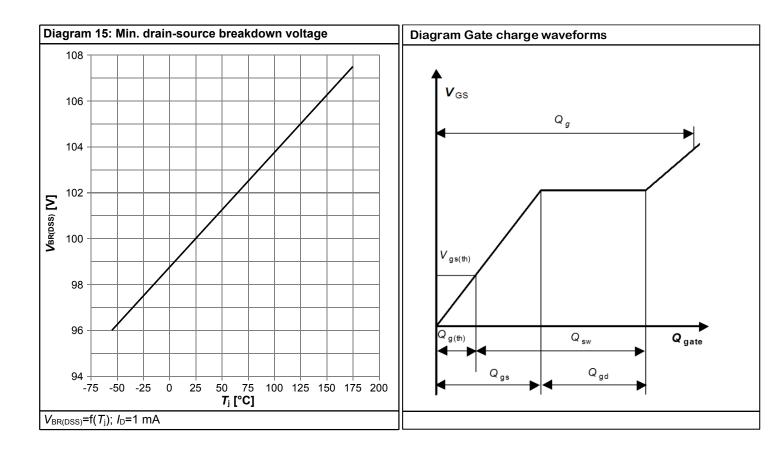














5 Package Outlines

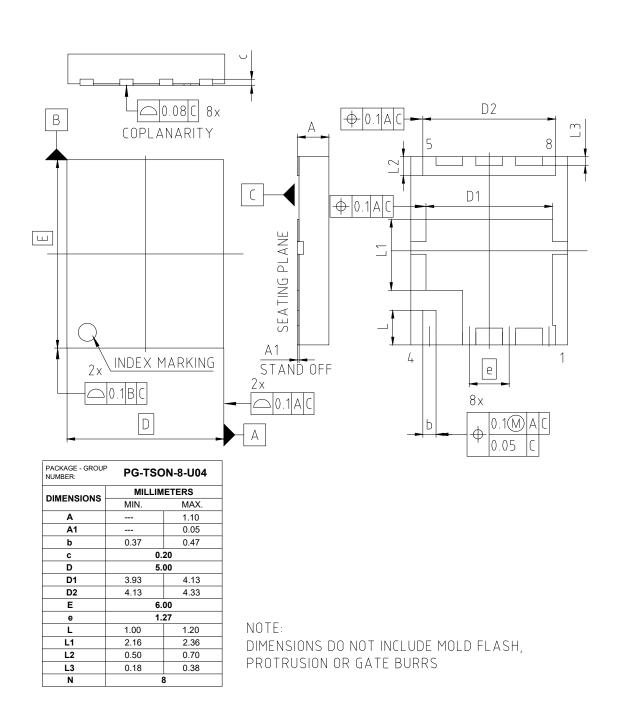


Figure 1 Outline PG-TSON-8, dimensions in mm

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Revision History

IQD020N10NM5

Revision: 2023-08-08, Rev. 2.0

Previous Revision

| Revision | Date | Subjects (major changes since last revision) |
|----------|------------|--|
| 2.0 | 2023-08-08 | Release of final version |

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